## ZXTP25100BFH <br> 100V, SOT23, PNP medium power transistor

## Summary

$\mathrm{BV}_{\text {(BR) CEX }}>-140 \mathrm{~V}, \mathrm{BV}_{\text {(BR)CEO }}>-100 \mathrm{~V}$
$B V_{\text {(BR)ECX }}>-7 V$;
$I_{C(\text { cont })}=-2 \mathrm{~A}$
$\mathrm{V}_{\mathrm{CE}(\text { sat })}<-130 \mathrm{mV}$ @ -1A

$R_{\text {CE(sat) }}=108 \mathrm{~m} \Omega$ typical
$\mathrm{P}_{\mathrm{D}}=1.25 \mathrm{~W}$

## Complementary part number ZXTN25100BFH

## Description

Advanced process capability and package design have been used to maximize the power handling and performance of this small outline transistor. The compact size and ratings of this device make it ideally suited to applications where space is at a premium.

## Features

- High power dissipation SOT23 package

- High peak current
- Low saturation voltage
- 140 V forward blocking voltaget
- 7V reverse blocking voltage


## Applications

- MOSFET and IGBT gate driving
- DC - DC converters


Pinout - top view

- Motor drive
- Relay, lamp, and solenoid drive


## Ordering information

| Device | Reel size <br> (inches) | Tape width | Quantity per reel |
| :--- | :---: | :---: | :---: |
| ZXTP25100BFHTA | 7 | 8 mm | 3,000 |

## Device marking

056

## ZXTP25100BFH

## Absolute maximum ratings

| Parameter | Symbol | Limit | Unit |
| :---: | :---: | :---: | :---: |
| Collector-base voltage | $\mathrm{V}_{\text {CBO }}$ | -140 | V |
| Collector-emitter voltage (forward blocking) | $V_{\text {CEX }}$ | -140 | V |
| Collector-emitter voltage | $\mathrm{V}_{\text {CEO }}$ | -100 | V |
| Emitter-collector voltage (reverse blocking) | $\mathrm{V}_{\text {ECX }}$ | -7 | V |
| Emitter-base voltage | $V_{\text {EBO }}$ | -7 | V |
| Continuous collector current ${ }^{\text {(b) }}$ | $\mathrm{I}_{\mathrm{C}}$ | -2 | A |
| Peak pulse current | $\mathrm{I}_{\text {CM }}$ | -5 | A |
| Power dissipation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (a) Linear derating factor | $\mathrm{P}_{\mathrm{D}}$ | $\begin{aligned} & 0.73 \\ & 5.84 \end{aligned}$ | $\begin{gathered} \mathrm{W} \\ \mathrm{~mW} /{ }^{\circ} \mathrm{C} \end{gathered}$ |
| Power dissipation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (b) Linear derating factor | $\mathrm{P}_{\mathrm{D}}$ | $\begin{gathered} 1.05 \\ 8.4 \end{gathered}$ | $\begin{gathered} \mathrm{W} \\ \mathrm{~mW} /{ }^{\circ} \mathrm{C} \end{gathered}$ |
| Power dissipation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (c) Linear derating factor | $P_{D}$ | $\begin{gathered} 1.25 \\ 9.6 \end{gathered}$ | $\begin{gathered} \mathrm{W} \\ \mathrm{~mW} /{ }^{\circ} \mathrm{C} \end{gathered}$ |
| Power dissipation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (d) Linear derating factor | $\mathrm{P}_{\mathrm{D}}$ | $\begin{aligned} & 1.81 \\ & 14.5 \end{aligned}$ | $\begin{gathered} \mathrm{W} \\ \mathrm{~mW} /{ }^{\circ} \mathrm{C} \end{gathered}$ |
| Operating and storage temperature range | $\mathrm{T}_{\mathrm{j}}, \mathrm{T}_{\text {stg }}$ | -55 to 150 | ${ }^{\circ} \mathrm{C}$ |

## Thermal resistance

| Parameter | Symbol | Limit | Unit |
| :--- | :---: | :---: | :---: |
| Junction to ambient ${ }^{\text {(a) }}$ | $\mathrm{R}_{\text {ӨJA }}$ | 171 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Junction to ambient ${ }^{\text {(b) }}$ | $\mathrm{R}_{\text {ӨJA }}$ | 119 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Junction to ambient $^{\text {(c) }}$ | $\mathrm{R}_{\text {ӨJA }}$ | 100 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Junction to ambient ${ }^{\text {(d) }}$ | $\mathrm{R}_{\text {ӨJA }}$ | 69 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## NOTES:

(a) For a device surface mounted on $15 \mathrm{~mm} \times 15 \mathrm{~mm} \times 1.6 \mathrm{~mm}$ FR4 PCB with high coverage of single sided 10 z copper, in still air conditions.
(b) Mounted on $25 \mathrm{~mm} \times 25 \mathrm{~mm} \times 1.6 \mathrm{~mm}$ FR4 PCB with a high coverage of single sided 2 oz copper in still air conditions.
(c) Mounted on $50 \mathrm{~mm} \times 50 \mathrm{~mm} \times 1.6 \mathrm{~mm}$ FR4 PCB with a high coverage of single sided 2 oz copper in still air conditions.
(d) As (c) above measured at $\mathrm{t}<5$ secs.

## ZXTP25100BFH

## Characteristics






Transient Thermal Impedance


## ZXTP25100BFH

## Electrical characteristics (at $\mathrm{T}_{\mathrm{AMB}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$ unless otherwise stated)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
| :--- | :--- | :---: | :---: | :---: | :---: | :--- |
| Collector-base breakdown <br> voltage | $\mathrm{BV}_{\mathrm{CBO}}$ | -140 | -165 |  | V | $\mathrm{I}_{\mathrm{C}}=-100 \mu \mathrm{~A}$ |
| Collector-emitter <br> breakdown voltage <br> (forward blocking) | $\mathrm{BV}_{\mathrm{CEX}}$ | -140 | -165 |  | V | $\mathrm{I}_{\mathrm{C}}=-100 \mu \mathrm{~A}$, <br> $\mathrm{R}_{\mathrm{BE}}<1 \mathrm{k} \Omega$ or <br> -0.25 V |
| Collector-emitter <br> breakdown voltage (base <br> open) | $\mathrm{BV}_{\mathrm{CEO}}$ | -100 | -125 |  | V | $\mathrm{I}_{\mathrm{C}}=-10 \mathrm{~mA}^{\left({ }^{*}\right)}$ |

## NOTES:

(*) Measured under pulsed conditions. Pulse width $\leq 300 \mu \mathrm{~s}$; duty cycle $\leq 2 \%$.

## ZXTP25100BFH

## Typical characteristics







## ZXTP25100BFH

## Package outline - SOT23



| Dim. | Millimeters |  | Inches |  | Dim. | Millimeters |  | Inches |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min. | Max. | Min. | Max. |  | Min. | Max. | Max. | Max. |
| A | 2.67 | 3.05 | 0.105 | 0.120 | H | 0.33 | 0.51 | 0.013 | 0.020 |
| B | 1.20 | 1.40 | 0.047 | 0.055 | K | 0.01 | 0.10 | 0.0004 | 0.004 |
| C | - | 1.10 | - | 0.043 | L | 2.10 | 2.50 | 0.083 | 0.0985 |
| D | 0.37 | 0.53 | 0.015 | 0.021 | M | 0.45 | 0.64 | 0.018 | 0.025 |
| F | 0.085 | 0.15 | 0.0034 | 0.0059 | N | 0.95 NOM |  | 0.0375 NOM |  |
| G | 1.90 NOM |  | 0.075 NOM |  | - | - | - | - | - |

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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